

INTERNATIONAL DIRECTORY OF LEAD-FREE SOLDER VENDORS

Company Address ☎ Phone ✉ Fax 🏠 Year Founded ⚔ Chairman ⚔ President ⚔ CEO ☆ COO ⚔ Other Title Advertisers are shown in Boldface type.	Product Name ✖ Introduced ❖ Form	Applications	Web Site ✖ Customer Contact 🌐 Additional Offices <i>CM = Consult Manufacturer</i>
AIM Montreal, Quebec H1E 2S4 Canada ☎ 401.463.5605 🏠 1936	CM ✖ CM ❖ CM	CM	aimsolder.com
AMTECH Solder Products Inc. 75 Schoolground Rd. Branford, CT 06405 ☎ 203.481.0362 ✉ 203.481.5033 🏠 1978 ★◆ Marcia Gesick	SynTECH-LF ✖ 2003 ❖ No-clean solder paste	Stencil printing	solderproducts.com ✖ Gilbert Roberge, Technical Support Manager groberge@aimtechinc.com
	NWS-4200-LF ✖ 2004 ❖ Water-soluble solder paste	Bumping	
Cobar Europe BV Aluminiumstraat 2 Breda, Holland ☎ +31.76.544.5566 ✉ +31.76.544.5577 🏠 1983 ★◆ Eli Westerlaken	S9M Series ✖ 2003 ❖ Paste	Stencil printing	cobar.com 🌐 USA: Cobar Solder Products Inc. Londonderry, NH 03053 ☎ 603.432.7500
	385 Series ✖ 2002 ❖ Flux	Wave soldering, selective soldering	
Cookson Electronics Semiconductor Packaging 200 Technology Dr. Alpharetta, GA 30005 ☎ 678.624.7393	CM ✖ CM ❖ CM	CM	cooksonelectronics.com
Henkel Corp. 15350 Barranca Pkwy. Irvine, CA 92618 ☎ 949.789.2500 ✉ 949.789.2595 ⚔ Patrick Trippel	Multicore LF318 ✖ 2005 ❖ Pb-free, no-clean paste	Stencil printing	electronics.henkel.com
	Multicore WS300 ✖ 2005 ❖ Pb-free, water wash paste	Stencil printing	
Indium Corporation of America 34 Robinson Rd. Utica, NY 13502 ☎ 315.853.4900 ✉ 315.853.1000 🏠 1934 ★ Greg Evans	Indium5.1 ✖ 2005 ❖ Pb-free solder paste	Stencil printing	indium.com ✖ Anita Brown, Marketing Communications Supervisor abrown@indium.com
	NF260 ✖ 2005 ❖ No-flow underfill	Underfill	
Kester 515 E. Touhy Ave. Des Plaines, IL 60018 ☎ 847.297.1600 or 800-2-KESTER ✉ 847.390.9338 🏠 1987 ★ Roger Savage	Ultra-Spheres SAC 305 ✖ 2004 ❖ Sphere	Ball attach, sphere drop	kester.com ✖ Eva Gerbac egerbac@kester.com ✖ Theresa Rudnick, Customer Service Mgr. trudnick@kester.com
	SE-CURE 7601 ✖ 2005 ❖ Paste	Substrate bumping, wafer bumping	
Nippon Micrometal Corp. Iruma-City, 358-0032 Japan ☎ +81.4.2934.6101 ✉ +81.4.2934.5454 🏠 1987 ★ Teruyuki Nishitani	LF35 ✖ 2002 ❖ Sphere	CM	nmc-net.co.jp ✖ Yoji Kawakami, GM Sales Dept. ykawa@nmc-net.co.jp 🌐 USA: SunSil Inc., Alamo, CA 94507 Seth Alavi, salavi@sunsil.com ☎ 925.648.7779

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Pure Technologies LLC 1266 West Paces Ferry Rd. NW #519, Atlanta, GA 30327 ☎ 404.351.6136 ☒ 404.350.0729 🏠 1994 🌟★ Jerald Cohn	CM ✖ CM ❖ CM	Substrate bumping, wafer bumping	puretechnologies.com ✱ Jerald Cohn, Chairman jerry@puretechnologies.com
Qualitek International Inc. 315 Fairbank St. Addision, IL 60101 ☎ 630.628.8083 ☒ 630.628.6543 🏠 1980 ★◆ Phodi Han	Green Pb-free solder paste ✖ 2005	Stencil printing, manual soldering	qualitek.com ✱ Richard Wicker, National Sales Manager rwicker@qualitek.com
	NC600 Pb-free ✖ 2004	CM	
Senju Comtek Corp. Adachi-ku, Tokyo, Japan ☎ 408.446.7866 (USA) 🏠 1997 ★ R.H. Suzuki	M705-GRN360 ✖ 1999 ❖ ECO solder paste	Substrate bumping, wafer bumping, manual soldering, etc.	senjucomtek.com 🌐 USA: Senju Comtek Corp. 1171 N. Fourth St., San Jose, CA 95112 ✱ Derek Daily, Assistant GM sales@senjucomtek.com
	ECO solder spheres ✖ 1999	Substrate bumping, wafer bumping	
Tamura Kaken Corp. Iruma-shi, 358-8501 Japan ☎ +81.42.934.6134 ☒ +81.42.935.1427 🏠 1956 ★ Yoshiki Takemura	LF-101-15 ✖ 2004 ❖ No-clean, Pb-free solder paste	Substrate bumping	tamura-kaken.co.jp 🌐 Tamura Kaken Corp. USA San Jose, CA 95131 ✱ Donald Ganschow, Sales & Mktg. Mgr. donald@tamurau.com
	LF-204-15 ✖ 2004 ❖ No-clean, Pb-free solder paste	Substrate bumping	